

DS26F32M

Quad Differential Line Receivers

General Description

The DS26F32 is a quad differential line receiver designed to meet the requirements of EIA Standards RS-422 and RS-423, and Federal Standards 1020 and 1030 for balanced and unbalanced digital data transmission.

The DS26F32 offers improved performance due to the use of state-of-the-art L-FAST bipolar technology. The L-FAST technology allows for higher speeds and lower currents by utilizing extremely short gate delay times. Thus, the DS26F32 features lower power, extended temperature range, and improved specifications.

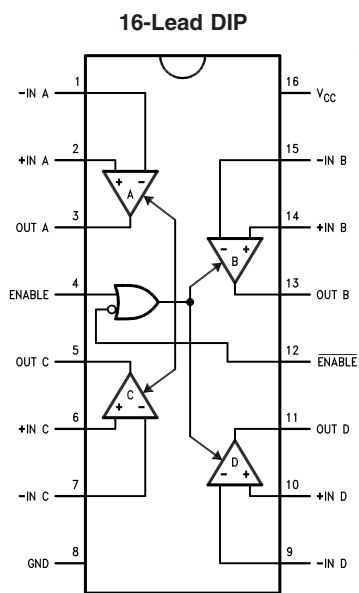
The device features an input sensitivity of 200 mV over the input common mode range of $\pm 7.0V$. The DS26F32 provides an enable function common to all four receivers and TRI-STATE® outputs with 8.0 mA sink capability. Also, a fail-safe input/output relationship keeps the outputs high when the inputs are open.

The DS26F32 offers optimum performance when used with the DS26F31 Quad Differential Line Driver.

Features

- Military temperature range
- Input voltage range of $\pm 7.0V$ (differential or common mode) $\pm 0.2V$ sensitivity over the input voltage range
- Meets all the requirements of EIA standards RS-422 and RS-423
- High input impedance (18k typical)
- 30 mV input hysteresis
- Operation from single +5.0V supply
- Input pull-down resistor prevents output oscillation on unused channels
- TRI-STATE outputs, with choice of complementary enables, for receiving directly onto a data bus
- Propagation delay 15 ns typical

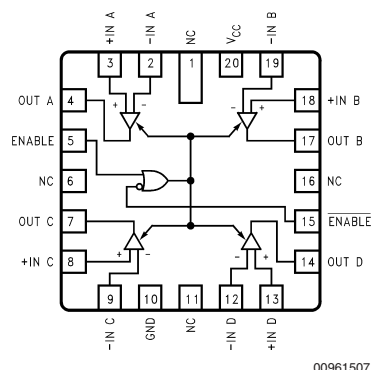
Connection Diagram



Top View

See NS Package Number J16A
For Complete Military Product Specifications,
refer to the appropriate SMD or MDS.
Order Number DS26F32ME/883,
DS26F32MJ/883 or DS26F32MW/883
See NS Package Number E20A, J16A or W16A

20-Lead Ceramic Leadless Chip Carrier



Function Table

(Each Receiver)

| Differential Inputs | Enables | Outputs |
|----------------------------------|-------------|---------|
| $V_{ID} = (V_{IN+}) - (V_{IN-})$ | E \bar{E} | OUT |
| $V_{ID} \geq 0.2V$ | H X | H |
| | X L | H |
| $V_{ID} \leq -0.2V$ | H X | L |
| | X L | L |
| X | L H | Z |

H = High Level

L = Low Level

X = Immaterial

Absolute Maximum Ratings (Note 2)

If Military/Aerospace specified devices are required, please contact the National Semiconductor Sales Office/ Distributors for availability and specifications.

| | |
|--|------------------|
| Storage Temperature Range | |
| Ceramic DIP | –65°C + to 175°C |
| Operating Temperature Range | |
| DS26F32M | –55°C to +125°C |
| DS26F32C | 0°C to +70°C |
| Lead Temperature | |
| Ceramic DIP (soldering, 60 sec) | 300°C |
| Maximum Power Dissipation (Note 1) at 25°C | |

| | |
|----------------------------|---------|
| Cavity Package | 1500 mW |
| Supply Voltage | 7.0V |
| Common Mode Voltage Range | ±25V |
| Differential Input Voltage | ±25V |
| Enable Voltage | 7.0V |
| Output Sink Current | 50 mA |

Operating Range

| | |
|----------------|-----------------|
| DS26F32M | |
| Temperature | –55°C to +125°C |
| Supply Voltage | 4.5V to 5.5V |

Note 1: Derate cavity package 10 mW/°C above 25°C.

Electrical Characteristics (Notes 3, 4)

Over operating range, unless otherwise specified

| Symbol | Parameter | Conditions | Min | Typ | Max | Units |
|------------|---|---|---------------------------|-------|-------|-------|
| V_{TH} | Differential Input Voltage | $-7.0V \leq V_{CM} \leq +7.0V$, $V_O = V_{OL}$ or V_{OH} | –0.2 | ±0.06 | +0.2 | V |
| R_I | Input Resistance | $-15V \leq V_{CM} \leq +15V$, One Input AC Ground | 14 | 18 | | kΩ |
| I_I | Input Current (under Test) | $V_I = +15V$, Other Input $-15V \leq V_I \leq +15V$ | | | 2.3 | mA |
| | | $V_I = -15V$, Other Input $-15V \leq V_I \leq +15V$ | | | –2.8 | |
| V_{OH} | Output Voltage HIGH | $V_{CC} = \text{Min}$, $\Delta V_I = +1.0V$, $V_{ENABLE} = 0.8V$, $I_{OH} = -440 \mu A$ | 0°C to +70°C | 2.8 | 3.4 | V |
| | | | –55°C to +125°C | 2.5 | 3.4 | |
| V_{OL} | Output Voltage LOW | $V_{CC} = \text{Min}$, $\Delta V_I = -1.0V$, $V_{ENABLE} = 0.8V$ | $I_{OL} = 4.0 \text{ mA}$ | | 0.4 | V |
| | | | $I_{OL} = 8.0 \text{ mA}$ | | 0.45 | |
| V_{IL} | Enable Voltage LOW | | | | 0.8 | V |
| V_{IH} | Enable Voltage HIGH | | 2.0 | | | V |
| V_{IC} | Enable Clamp Voltage | $V_{CC} = \text{Min}$, $I_I = -18 \text{ mA}$ | | | –1.5 | V |
| I_{OZ} | Off State (High Impedance) Output Current | $V_{CC} = \text{Max}$ | $V_O = 2.4V$ | | 20 | μA |
| | | | $V_O = 0.4V$ | | –20 | |
| I_{IL} | Enable Current LOW | $V_I = 0.4V$ | | –0.2 | –0.36 | mA |
| I_{IH} | Enable Current HIGH | $V_I = 2.7V$ | | 0.5 | 10 | μA |
| I_I | Enable Input High Current | $V_I = 5.5V$ | | 1.0 | 50 | μA |
| I_{OS} | Output Short Circuit Current | $V_O = 0V$, $V_{CC} = \text{Max}$, (Note 5) $\Delta V_I = +1.0V$ | –15 | –50 | –85 | mA |
| I_{CC} | Supply Current | $V_{CC} = \text{Max}$, All $V_I = \text{GND}$, Outputs Disabled | | 30 | 50 | mA |
| V_{HYST} | Input Hysteresis | $T_A = 25^\circ\text{C}$, $V_{CC} = 5.0V$, $V_{CM} = 0V$ | | 30 | | mV |

Note 2: “Absolute Maximum Ratings” are those values beyond which the safety of the device cannot be guaranteed. They are not meant to imply that the devices should be operated at these limits. The tables of “Electrical Characteristics” provide conditions for actual device operation.

Note 3: Unless otherwise specified min/max limits apply across the –55°C to +125°C temperature range for the DS26F32M and across the 0°C to +70°C range for the DS26F32C. All typicals are given for $V_{CC} = 5V$ and $T_A = 25^\circ\text{C}$.

Note 4: All currents into the device pins are positive; all currents out of the device pins are negative. All voltages are reference to ground unless otherwise specified.

Note 5: Only one output at a time should be shorted.

Switching Characteristics

$V_{CC} = 5.0V$, $T_A = 25^\circ C$

| Symbol | Parameter | Conditions | | Min | Typ | Max | Units |
|-----------|------------------|----------------|----------------------|-----|-----|-----|-------|
| t_{PLH} | Input to Output | (Figures 2, 3) | $C_L = 15\text{ pF}$ | | 15 | 22 | ns |
| t_{PHL} | Input to Output | | | | 15 | 22 | ns |
| t_{LZ} | Enable to Output | (Figures 2, 4) | $C_L = 5\text{ pF}$ | | 14 | 18 | ns |
| t_{HZ} | Enable to Output | | | | 15 | 20 | ns |
| t_{ZL} | Enable to Output | | $C_L = 15\text{ pF}$ | | 13 | 18 | ns |
| t_{ZH} | Enable to Output | | | | 12 | 16 | ns |

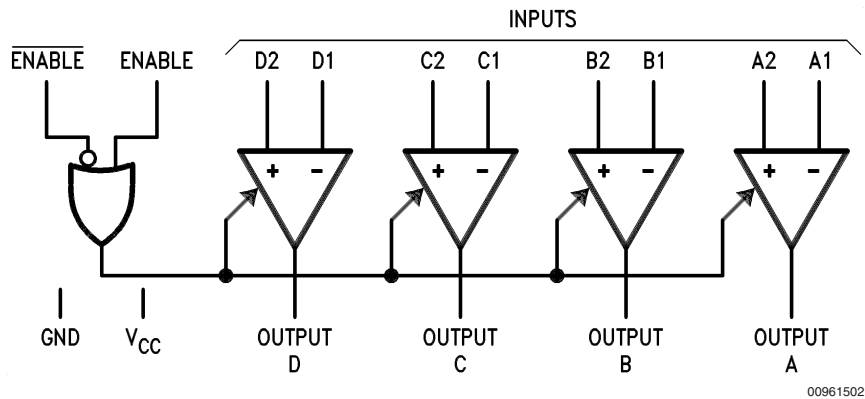


FIGURE 1. Logic Symbol

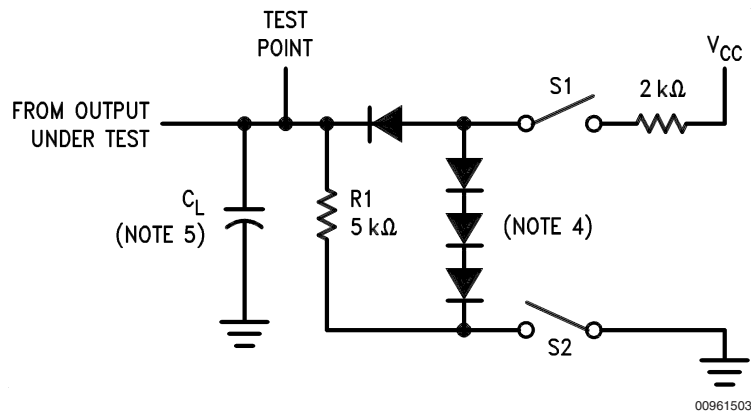


FIGURE 2. Load Test Circuit for Three-State Outputs

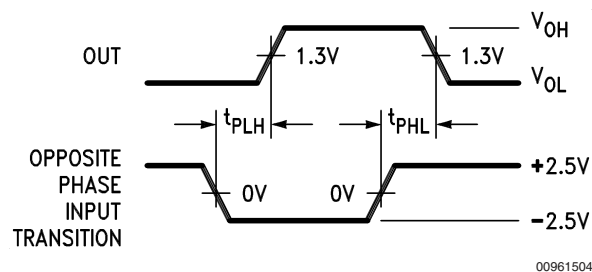


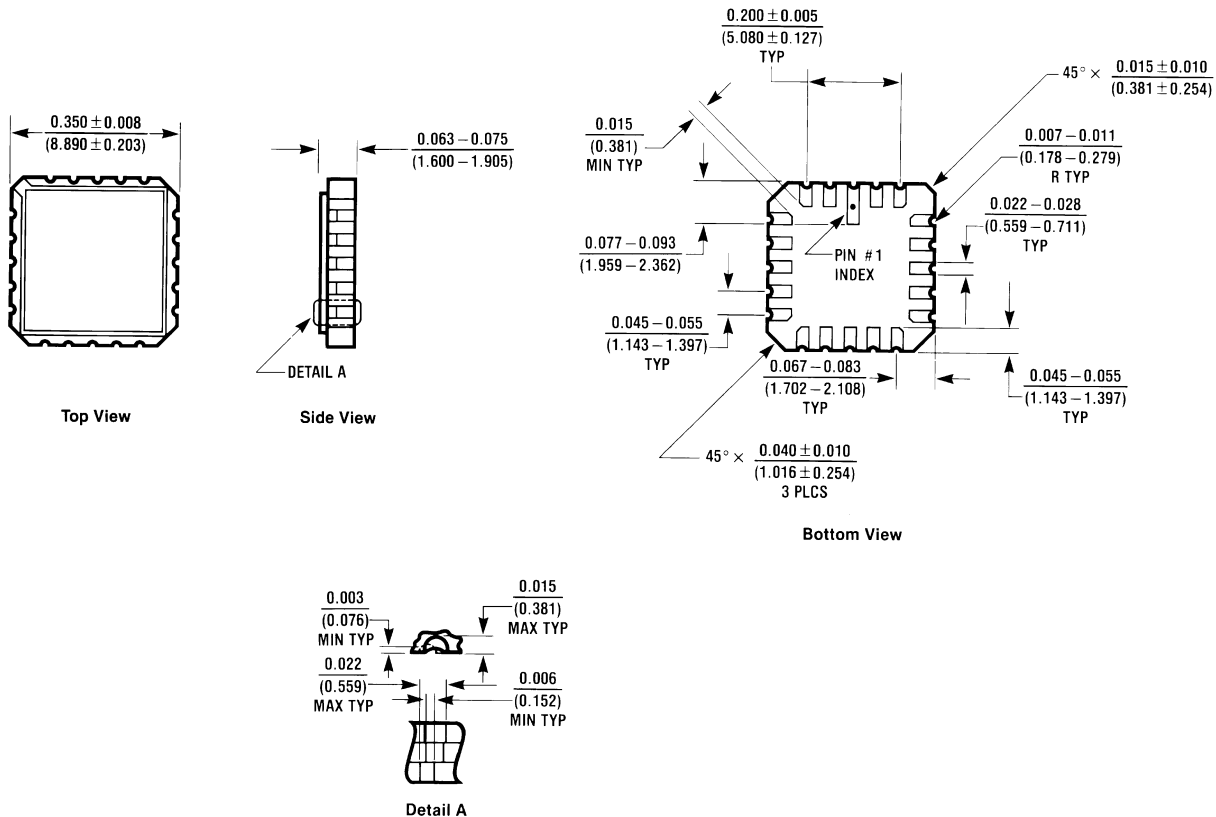
FIGURE 3. Propagation Delay (Notes 6, 7, 8)

The diagram illustrates a 1:1 data bus driver circuit. It begins with a 'DATA IN' signal entering a 1/4 DS26F31 driver. The DS26F31 has two outputs: a top line and a bottom line. These lines are connected to two 1/4 DS26F32 receivers. The top line is connected to the non-inverting input (+) of the first DS26F32, which produces a 'DATA OUT' signal. The bottom line is connected to the inverting input (-) of the second DS26F32, which also produces a 'DATA OUT' signal. A resistor labeled R_T is connected between the two output lines of the DS26F31, with its other end connected to ground. The DS26F32 components are configured as 1/4 units, indicating they are part of a larger multi-channel device.

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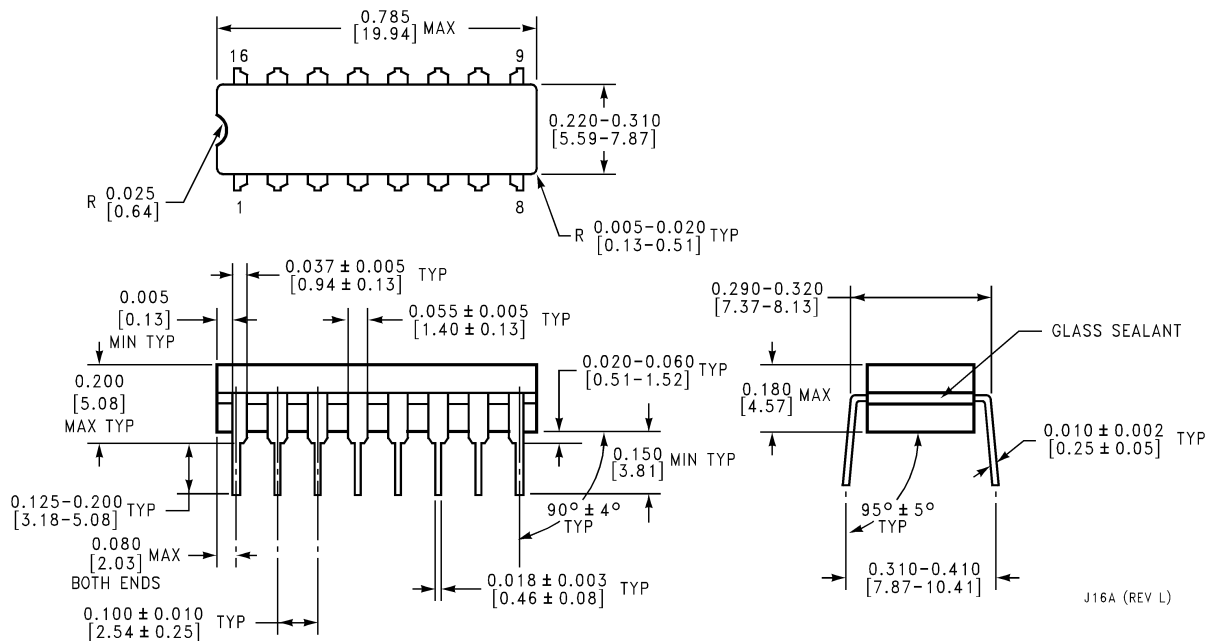
Physical Dimensions inches (millimeters)

unless otherwise noted



E20A (REV D)

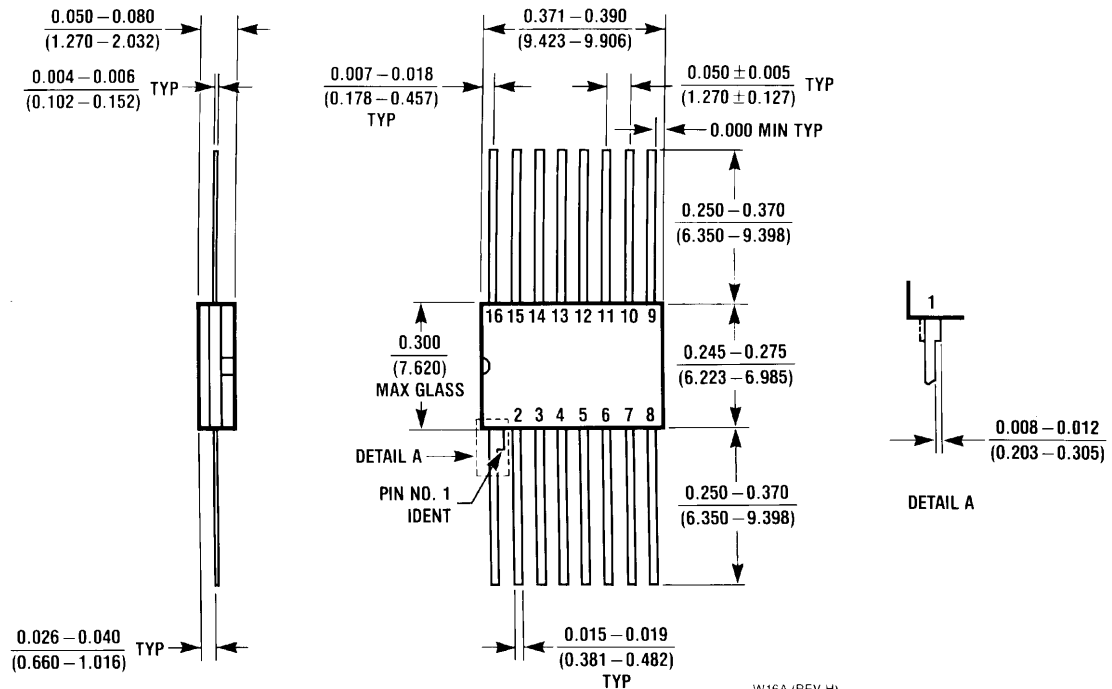
Order Number DS26F32ME/883
NS Package Number E20A



J16A (REV L)

Ceramic Dual-In-Line Package (J)
Order Number DS26F32MJ/883
NS Package Number J16A

Physical Dimensions inches (millimeters) unless otherwise noted (Continued)



Order Number DS26F32MW/883
NS Package Number W16A

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